



BOX PATENT

Attorney Docket No. 90040

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

CAPOTE et al.

Appln. No.: 09/935,432

Group Art Unit: 2815

Date Filed: August 21, 2001

Examiner: unknown

Title: **SEMICONDUCTOR FLIP-CHIP ASSEMBLY WITH PRE-APPLIED
ENCAPSULATING LAYERS**

TRANSMITTAL LETTER

Commissioner for Patents
Washington, D.C. 20231

Sir:

Submitted herewith for filing in the U.S. Patent and Trademark
Office is the following:

- (1) Transmittal Letter;
- (2) Revocation and Power of Attorney;
- (3) Certificate under 37 C.F.R. § 3.73(b); and
- (4) Copy of Assignment filed in parent application 09/137,971.

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JUN 13 2002
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Respectfully submitted,

NATH & ASSOCIATES PLLC

By: 

Gary M. Nath
Registration No. 26,965
Marvin C. Berkowitz
Registration No. 47,421
Customer No. 20529

Date: June 12, 2002
NATH & ASSOCIATES, PLLC
1030 15th Street N.W., 6th Floor
Washington, D.C. 20005
Tel. (202) 775-8383
Fax (202) 775-8396
GMN/MCB/twk:X-fer - xmittal.letter